

### Identification and Validation of Analytical Chemistry Methods for Detecting Composite Surface Contamination and Moisture

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### Introduction





- Motivation and Key Issues
  - Adhesive bonding has been used in the manufacture and repair as a direct competition to mechanical fastening.
  - Adherend surface preparation is a critical issue to the structural integrity and durability of bonded structures.
- Objective
  - benchmark surface preparation quality assurance methods
  - identify and validate definitive analytical chemistry methods to provide sufficient in-field quality assurance.
- Approach
  - Literature review and analysis
  - Surface chemistry analysis
  - Electrochemical sensor development
  - Experimental validation



## FAA Sponsored Project Information



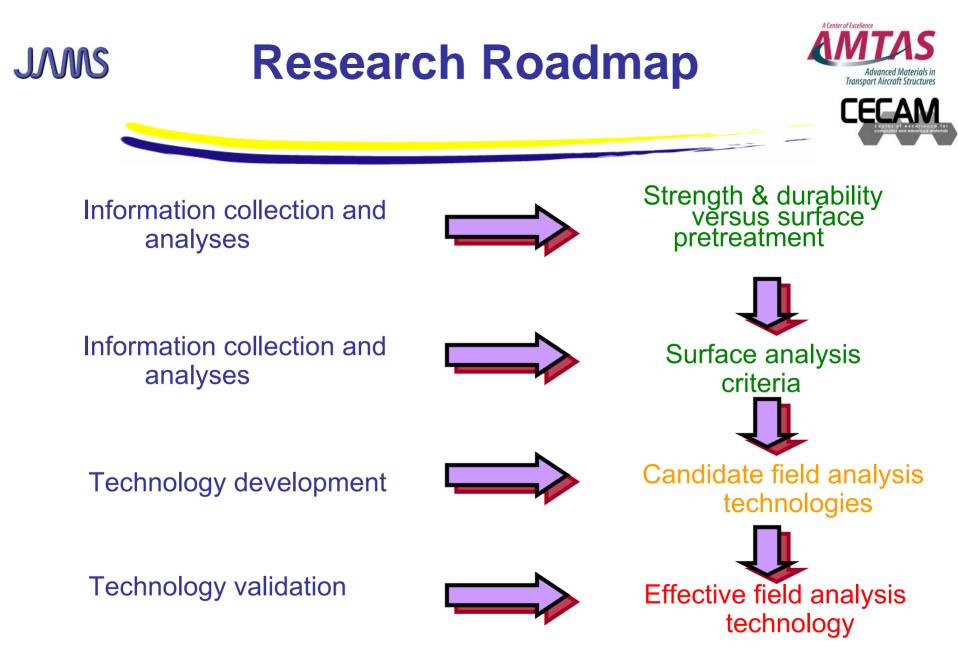
- PI & Researchers
  - Richard Burton, Rajiv Srivastava, Weihua Chang, Dwayne McDaniel, Wongbon Choi, Xiangyang Zhou
- Students
  - Sam Hill, Yao Ge, Shejie Tang, Ling Wang
- FAA Technical Monitor
  - Drs. Jim White & Curtis Davies
- Industry Participation
  - DME, Avborne, AeroMatrix

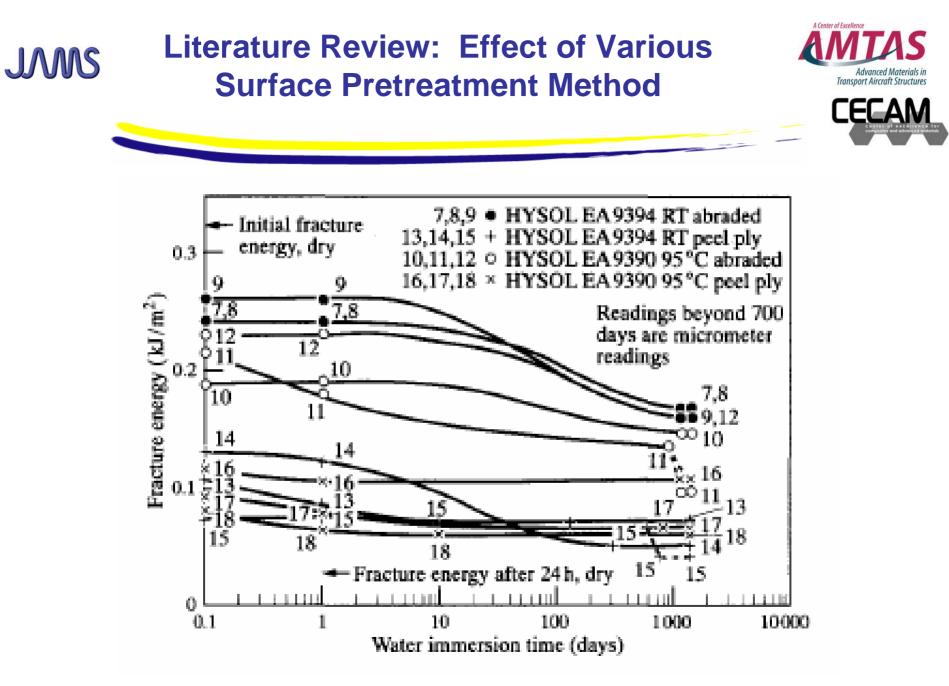


# **Main Results**



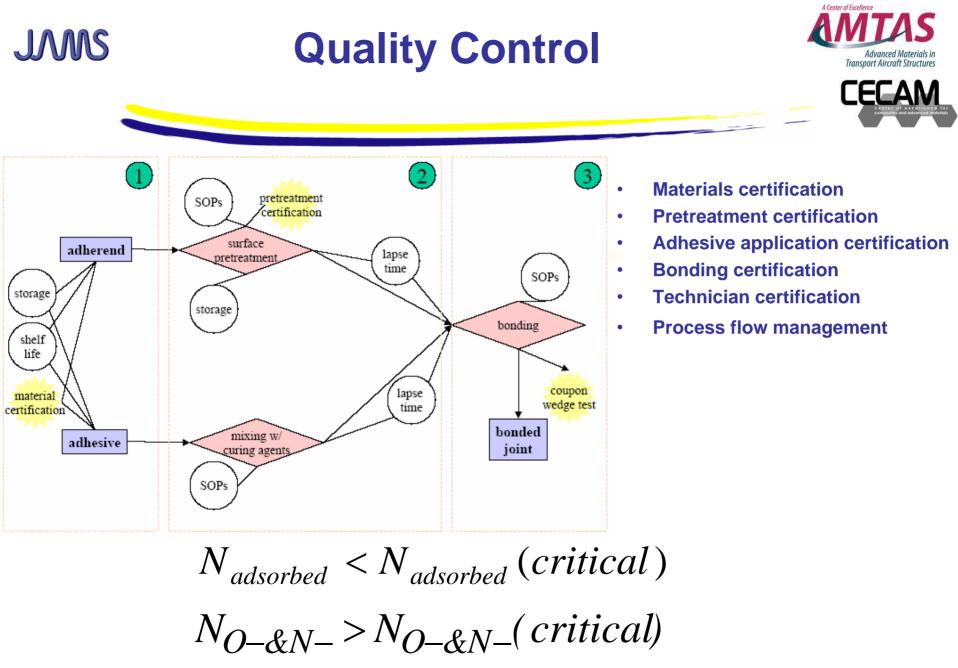
- Literature database, complete
- Summary of literature review
  - Surface treatment, complete
  - Surface chemistry analyses, complete
- An electrochemical sensor for surface chemistry analysis, testing in progress
- Carbon nano-tube sensor for humidity sensing, testing in progress
- AFM/SEM study of surface-contamination (peel-plies, etc),testing in progress

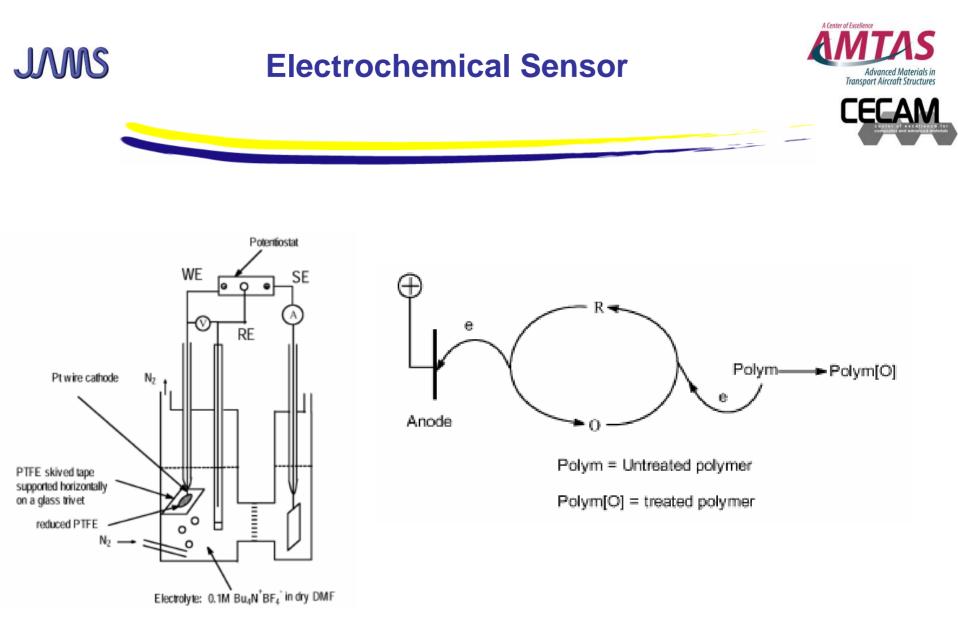




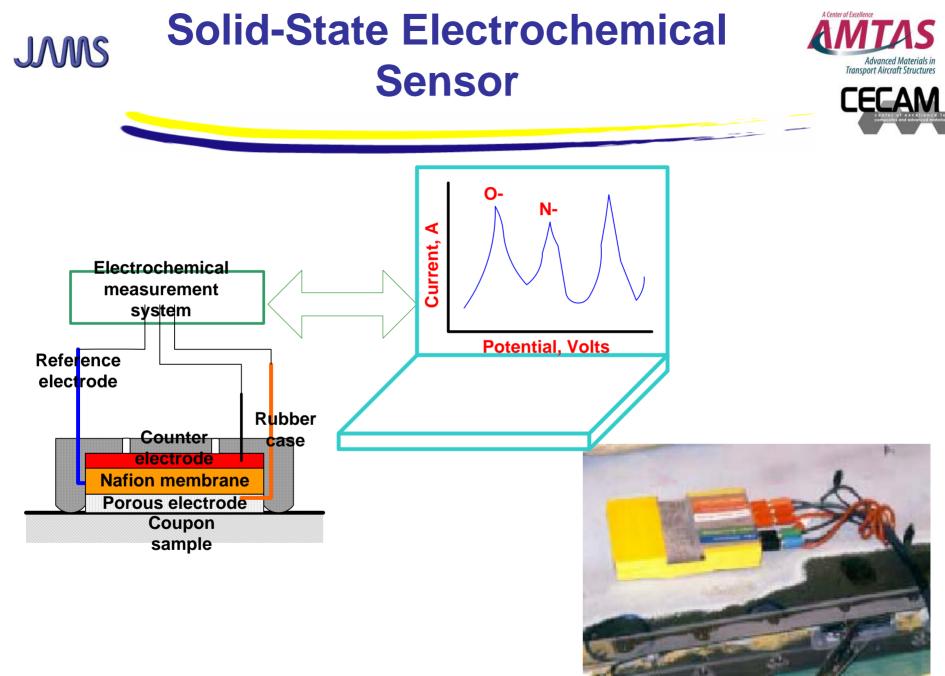


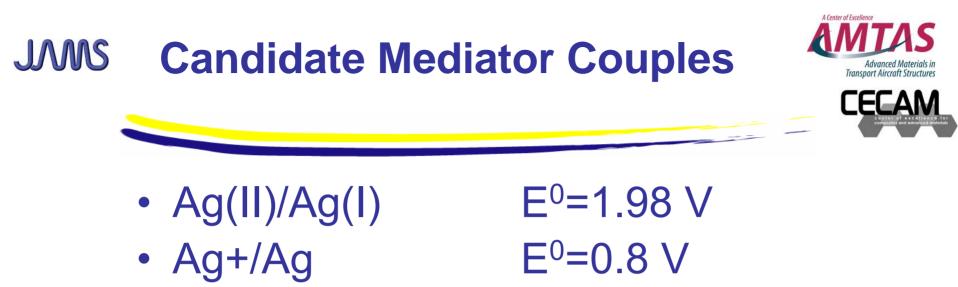
Polymer	Treatment	Surface composition (at%)		Failure load/N
		с	0	
HDPE	No treatment	100.0	0.0	400
	2.1 V, Pt edge, 50 passes	95.5	4.5	1330
	2.4 V, Pt edge, 50 passes	96.2	3.8	1320
	2.9 V, Pt disc, 5 min	92.4	7.6	1110
PP	No treatment	100.0	0.0	0
	3.25 M nitric acid, 60 s	_	_	267
	2.1 V, Pt edge, 50 passes	92.6	7.4	20.60
	2.4 V, Pt edge, 50 passes	93.1	6.9	2560
	2.9 V, Pt edge, 50 passes (H <sub>2</sub> SO <sub>4</sub> <sup>-</sup> )	100	0	50
	2.9 V, Pt disc, 300 s, not touching	_	_	270
	2.9 v, Pt disc, 300 s, far removed	_	_	390
SBS	No treatment	100.0	0.0	_
	2.5 V, Pt edge, 50 passes	83.6	14.6 <sup>b</sup>	_
PS	No treatment	100.0	0.0	550
	2.9 V, Pt disc, 300 s	94.5	5.5	670





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- Ce(IV)/Ce(III) E<sup>0</sup>=1.72 V
- Co(III)/Co(II)
- |<sub>2</sub>/|-
- Fe(CN)<sub>6</sub><sup>-4</sup>/Fe(CN)<sub>6</sub><sup>-3</sup>
- Fe<sup>+3</sup>/Fe<sup>+2</sup>

- E<sup>0</sup>=1.83 V E<sup>0</sup>=0.54 V
- E<sup>0</sup>=0.36 V
- E<sup>0</sup>=0.77 V

## **Solid-State Electrolyte**



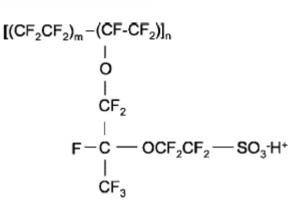
Nafion + Nafion Resin (Sulfonated tetrafluorethylene copolymer)

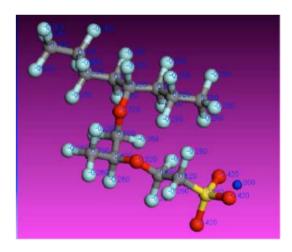
Extremely resistant to chemical attack

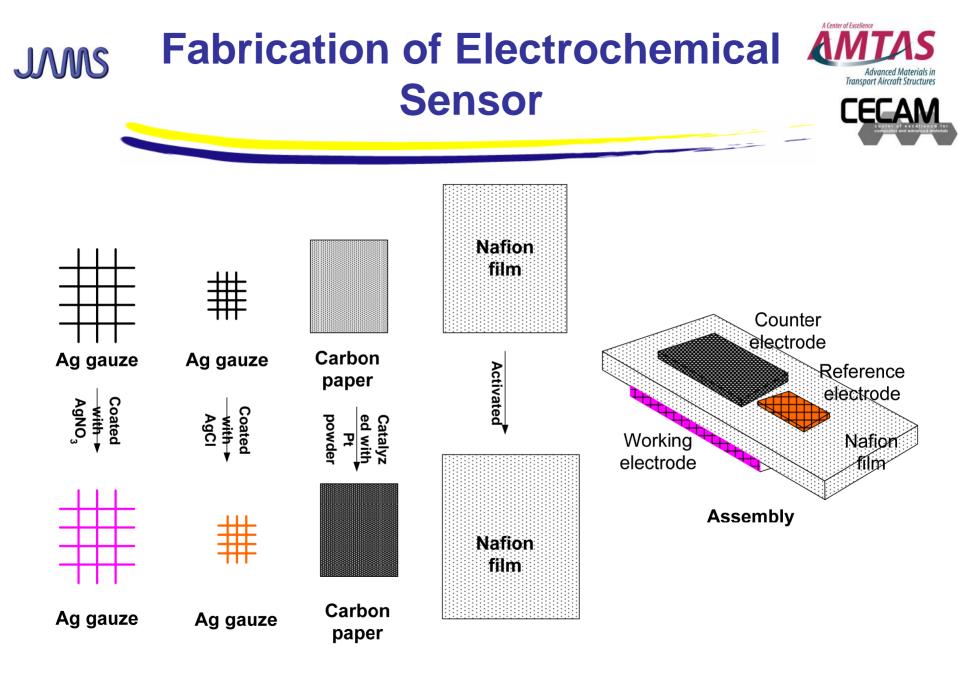
**Proton conductor** 

Strong proton donor and free electron acceptor-superacid catalysts (neutral pH)

Minimum oxidation and reduction of water





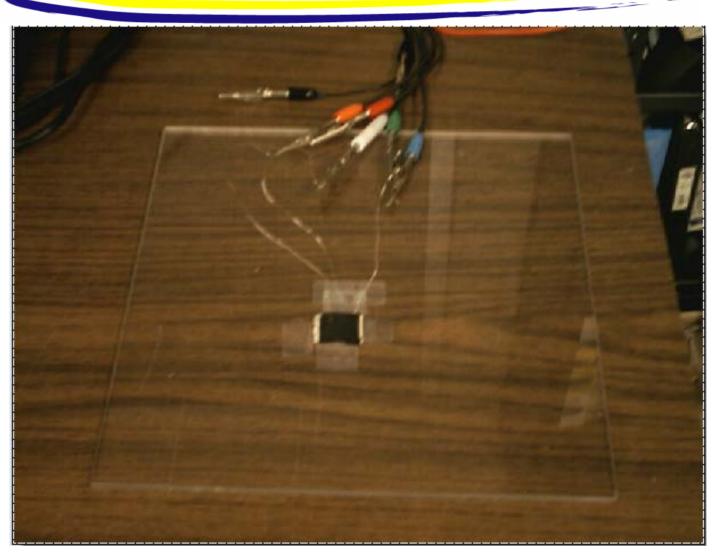


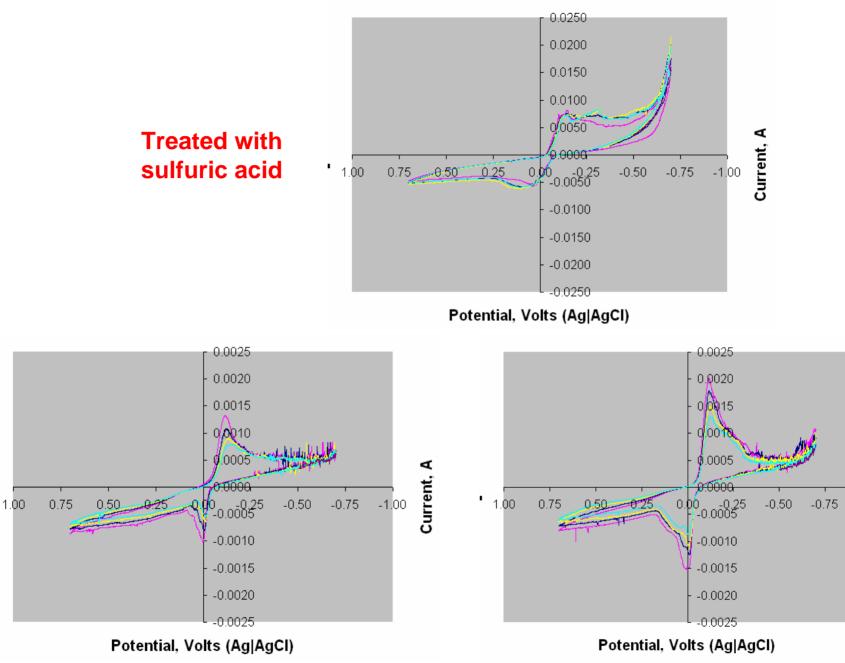


### Solid-state Electrochemical Sensor







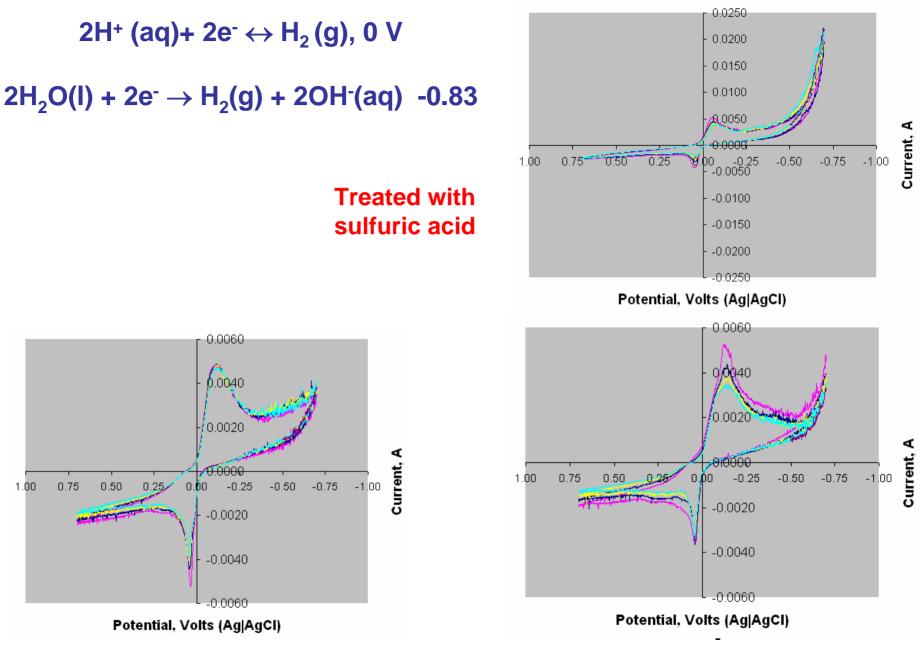


**Original acrylic plastic surface** 

**Polished acrylic plastic surface** 

Current, A

-1.00

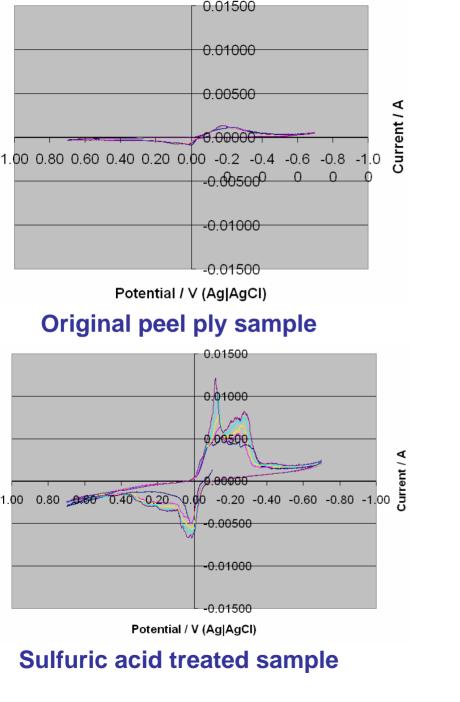


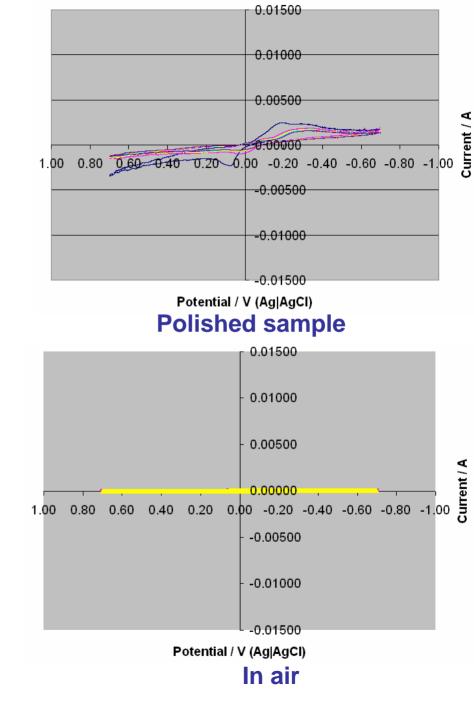
**Original acrylic plastic surface** 

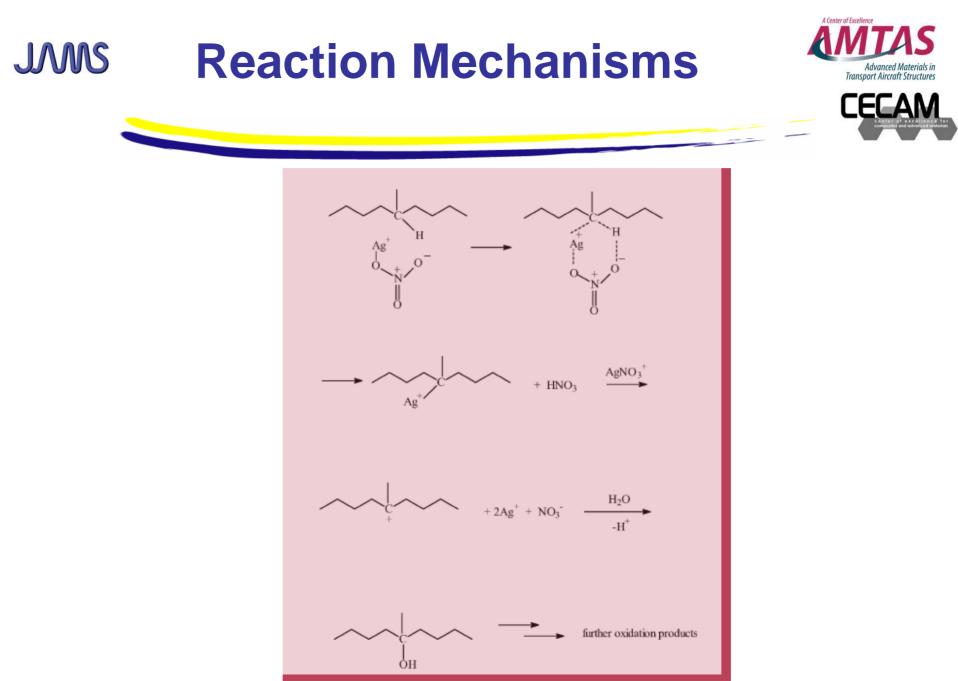
**Polished acrylic plastic surface** 



- Original surface: after removing peel ply
- Polished surface: polished using polishing paper (#600), and wiped with paper.
- Sulfuric acid etched: immersed in 50% sulfuric acid for 1-2 seconds, washed with DI water, and dried.









Treatment with sulfuric acid produces

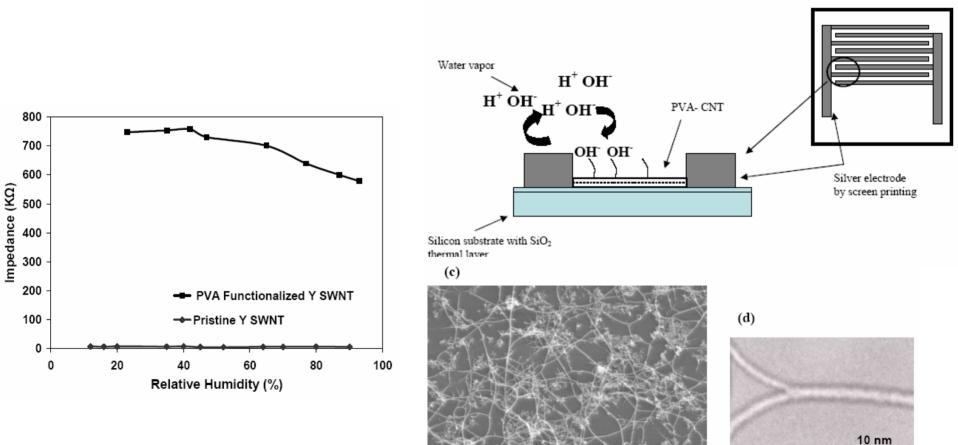
Hydroxyl, carbonyl, carboxylic acid, phenol, and sulfonated groups, ions, or fragments that may be very unstable and can be reduced or oxidized at certain potentials. The surface chemistry can be analyzed using XPS and FTIR.

The electrochemical sensor can detect these groups, ions, or fragments on the surfaces.



## Carbon Nanotube Based Humidity Sensor





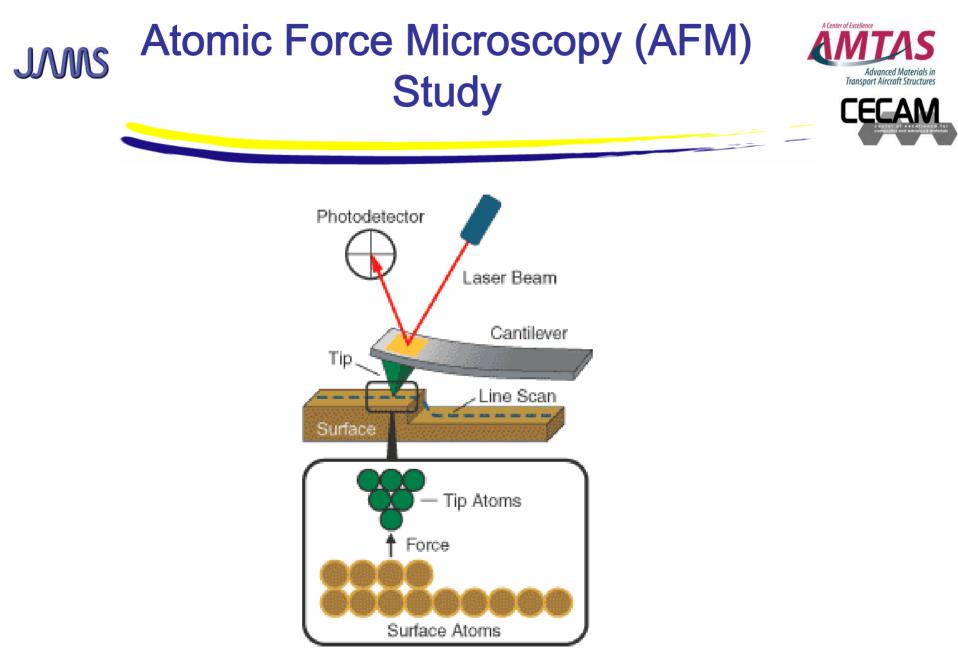
#### The Joint Advanced Materials and Structures Center of Excellence

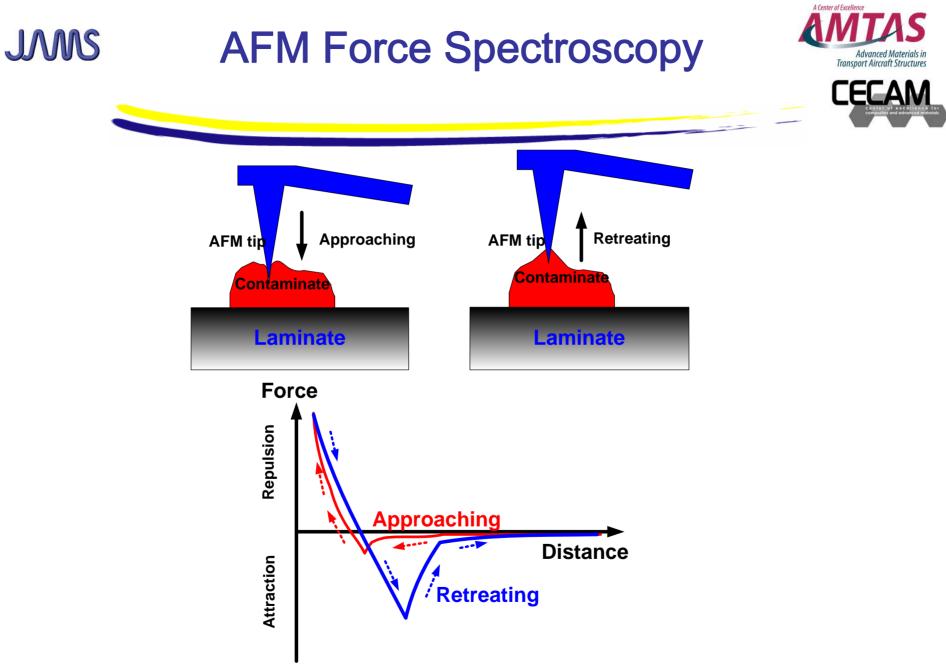
SEI

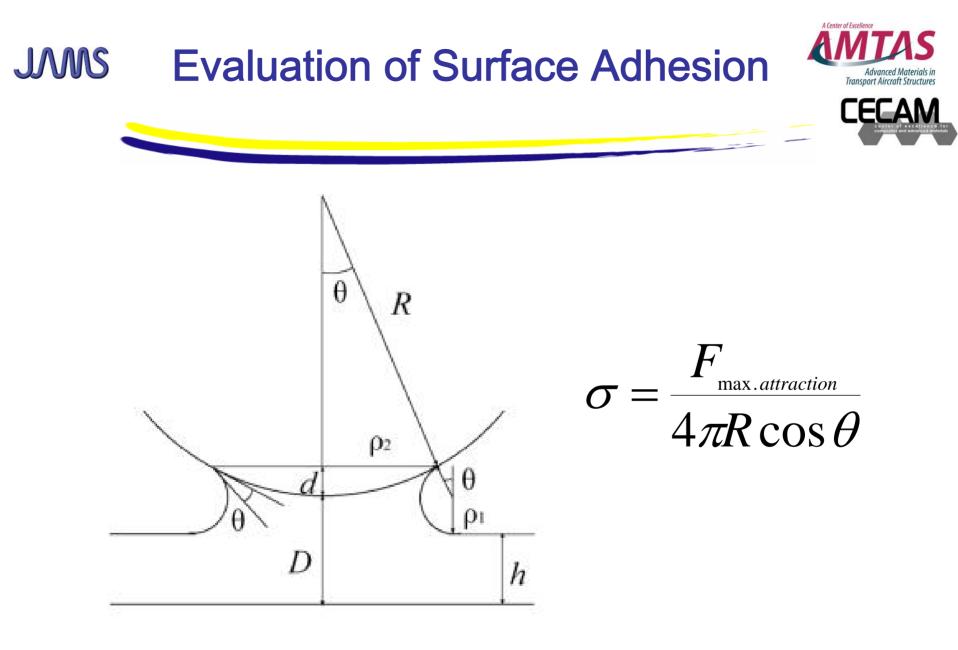
15.0kV X20.000

WD 36.8m

AMEB



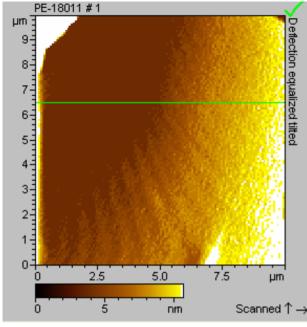


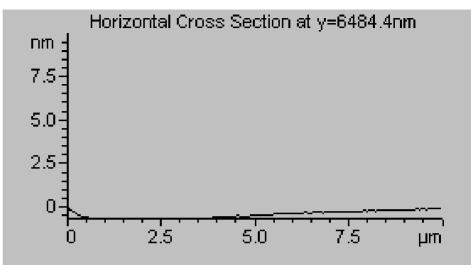


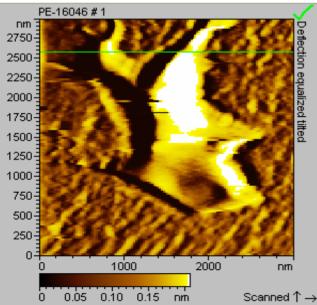


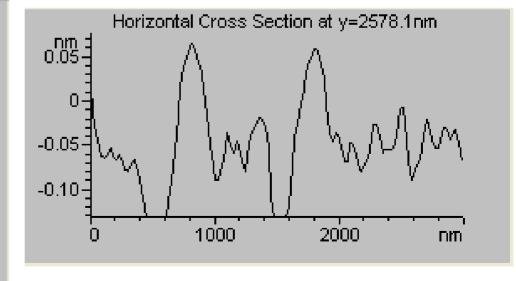
- Polyester (PF 60001): No transfer, strong bonds
- SRB (PF 60001): Siloxane coating transfer, weak bonds
- Nylon (PF 52006): Fiber transfer, bond strength depends on adhesive

### **Polyester Peel Ply Surface**

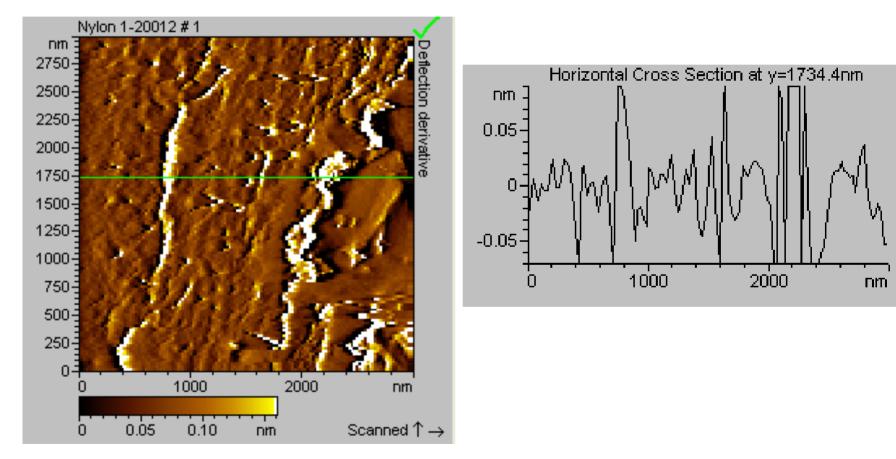




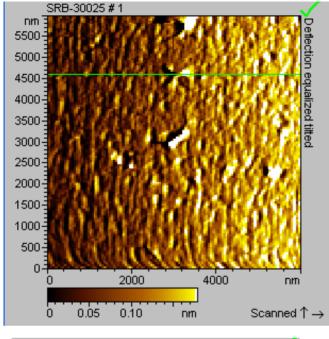


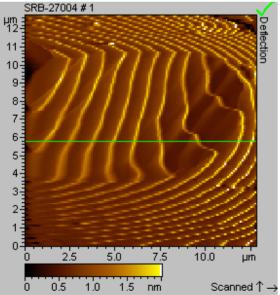


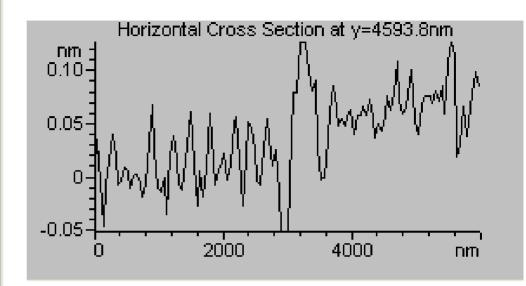


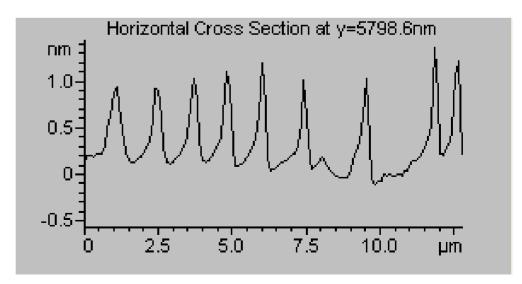


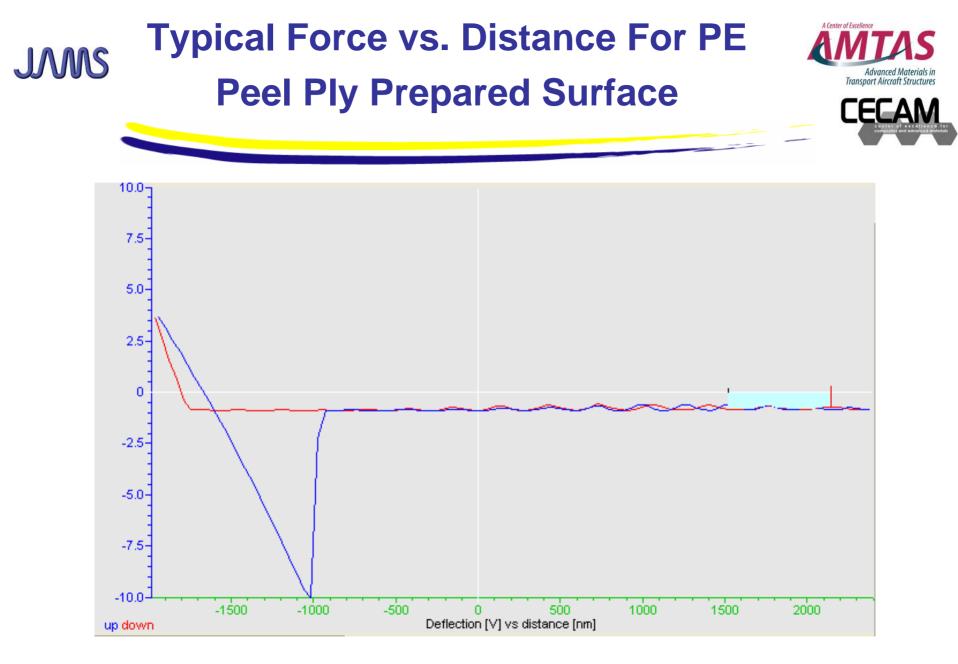
### **SRB Peel Ply Surface**

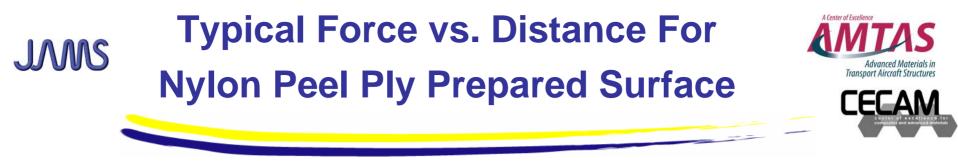


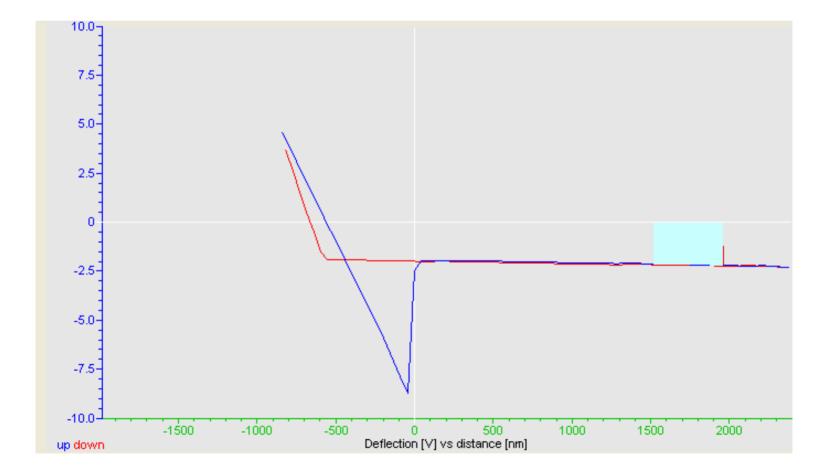












### A Center of Excellence **Typical Force vs. Distance For SRB** JMS Advanced **Peel Ply Prepared Surface** Transport Aircraft Structures 10.0 smooth (average) filter 7.5 5.0 2.5-0 -2.5--5.0 -7.5

### -10.0 -1500 -1000 -500 0 500 1000 1500 2000 up down Deflection [V] vs distance [nm]



# Conclusions



- Certification of pre-bond surface preparation quality requires implementation of effective surface chemistry inspection technologies for each and every step of the surface preparation procedure to ensure the strength and durability of the bonded aviation structures.
- Solid-state electrochemical sensor can detect contamination on peel ply surfaces and is a promising technology for in-field surface chemistry analysis.



- AFM can evaluate the contamination and damage of the laminates surfaces prepared with peel plies.
- AFM force spectroscopy can evaluate adhesion of the surfaces prepared with peel plies. The adhesion of laminate surfaces prepared with PE and nylon peel plies is greater than that of the surface prepared with SRB peel ply, correlating with bond strength and contamination level.



# **A Look Forward**





- Benefit to Aviation
  - Better understanding of the pre-bond surface preparation methods
  - Better understanding of bond strength and durability versus surface preparation
  - Novel in-field, online certification and assurance technology for surface preparation
  - Reduced costs for surface preparation and adhesive bonding processes
- Future needs
  - In-field, online analytical detection and monitoring technologies for manufacture, chemical, environmental, and energy industries.